

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5865919

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NAN WANG	10/08/2019
RECEIVING PARTY DATA	
Name:	SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION
Street Address:	18 WENCHANG RD., ECONOMIC TECHNOLOGICAL DEVELOPMENT AREA
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State/Country:	CHINA
Postal Code:	100176
Name:	SEMICONDUCTOR MANUFACTURING INTERNATIONAL (SHANGHAI) CORPORATION
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Internal Address:	PUDONG NEW AREA
City:	SHANGHAI
State/Country:	CHINA
Postal Code:	201203
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16601883
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ATTORNEY DOCKET NUMBER:	15741-71

NAME OF SUBMITTER:	ANDREA MCKAY
SIGNATURE:	/Andrea McKay/
DATE SIGNED:	12/13/2019
Total Attachments: 2 source=15741-71_Assignment#page1.tif source=15741-71_Assignment#page2.tif	

Case No. 15741-71 (2018-00423-SH-US)

ASSIGNMENT

WHEREAS, **NAN WANG**, the "Assignor", has made the invention described in the United States patent application entitled **SEMICONDUCTOR STRUCTURE AND METHOD FOR FORMING SAME**, executed by Assignor on the same date as, or on a date prior to, this Assignment,

WHEREAS, **Semiconductor Manufacturing International (Beijing) Corporation**, a corporation organized and existing under the laws of the Country of China, having a place of business at 18 Wenchang Road, Beijing Economic-Technological Development Area, Beijing 100176, China, and **Semiconductor Manufacturing International (Shanghai) Corporation**, a corporation organized and existing under the laws of the Country of China, having a place of business at 18 Zhangjiang Road, Pudong New Area, Shanghai, 201203, China, hereinafter the "Assignee", desires to acquire the entire right, title and interest in the invention and the patent application identified above, and all patents which may be obtained for the invention, as set forth below;

NOW, THEREFORE, in consideration of valuable and legally sufficient consideration, the receipt of which by the Assignor from the Assignee is acknowledged, the Assignor has sold, assigned and transferred, and by these presents sells, assigns and transfers to the Assignee, the entire right, title and interest for the United States in the invention and the patent application identified above, and any patents that may issue for the invention in the United States; with the entire right, title and interest in the invention and all patent applications and patents issuing therefrom in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; with the entire right, title and interest in all continuations, divisions, renewals and extensions of any of the patent applications and patents defined above; with the right to recover all damages, including, but not limited to, a reasonable royalty, by reason of past, present, or future infringement or any other violation of patent or patent application rights; to have hold for the sole and exclusive use

and benefit of the Assignee, its successors and assigns, to the full end of the term or terms for all such patents.

The Assignor covenants and agrees, for both the Assignor and the Assignor's legal representatives, that the Assignor will assist the Assignee in the prosecution of the patent application identified above; in the making and prosecution of any other patent applications that the Assignee may elect to make covering the invention identified above; in vesting in the Assignee like exclusive title in all such other patent applications and patents; and that the Assignor will execute and deliver to the Assignee any and all additional papers which may be requested by the Assignee to carry out the terms of this Assignment.

The Commissioner of Patents and Trademarks is authorized and requested to issue patents to the Assignee under the terms of this Assignment.

IN TESTIMONY WHEREOF, the Assignor has executed this agreement.

DATED:

2019-10-08

王楠
Nan WANG